

# **Description**

The VSM8205t uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

•  $V_{DS} = 20V, I_D = 5A$ 

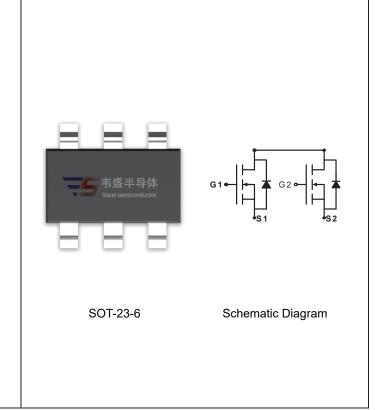
 $R_{DS(ON)}$  <32m $\Omega$  @  $V_{GS}$ =2.5V

 $R_{DS(ON)}$  < 23m $\Omega$  @  $V_{GS}$ =4.5V

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

# **Application**

- Battery protection
- Load switch
- Power management



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM8205t-S6	VSM8205t	SOT-23-6	Ø180mm	8mm	3000 units

## Absolute Maximum Ratings (T<sub>A</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	20	V	
Gate-Source Voltage	V <sub>G</sub> s	±12	V	
Drain Current-Continuous	I <sub>D</sub>	5	Α	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	25	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.25	W	
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 150	$^{\circ}$	

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{ heta JA}$	100	°C/W	
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## Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20			V



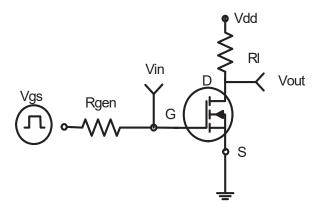
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =19.5V,V <sub>GS</sub> =0V	-	-	1	μA
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.5	0.7	1.2	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =4.5V, $I_{D}$ =5A	-	16.5	23	mΩ
Dialit-Source Off-State Resistance		$V_{GS}$ =2.5 $V$ , $I_{D}$ =5 $A$	-	22	32	mΩ
Forward Transconductance	<b>g</b> FS	$V_{DS}$ =5 $V$ , $I_{D}$ =5 $A$	-	10	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, F=1.0MHz	-	550	-	PF
Output Capacitance	Coss		-	125	ı	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0WH12	-	64	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD}$ =10V, $I_{D}$ =5A $V_{GS}$ =4V, $R_{GEN}$ =10 $\Omega$	-	9	ı	nS
Turn-on Rise Time	t <sub>r</sub>		-	10	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	32	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	24	ı	nS
Total Gate Charge	Qg	\/=10\/	-	9.5	ı	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=10V,I_{D}=5A,$ $V_{GS}=4.5V$	-	2.1	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	v GS-4.5 v	-	1.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =5A	-	8.0	1.2	V
Diode Forward Current (Note 2)	Is		-	-	5	А

## Notes:

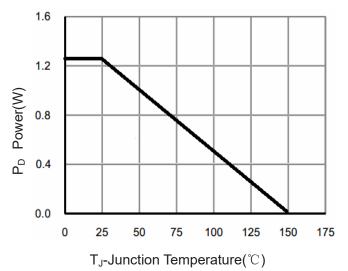
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
  3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



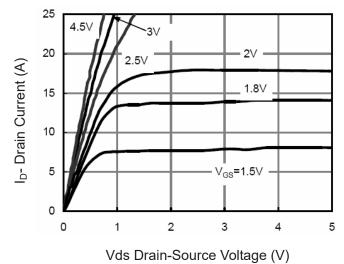
## **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 



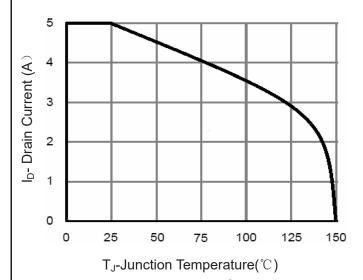
**Figure 3 Power Dissipation** 



**Figure 5 Output Characteristics** 



Figure 2:Switching Waveforms



**Figure 4 Drain Current** 

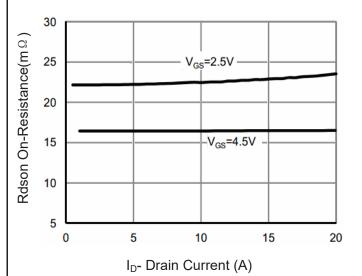
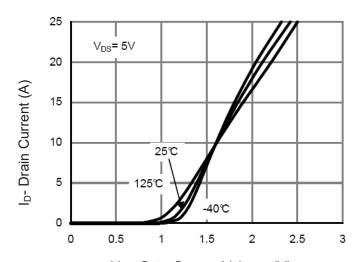
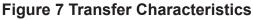


Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V)



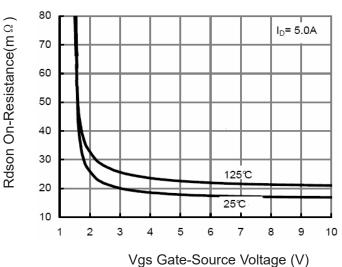
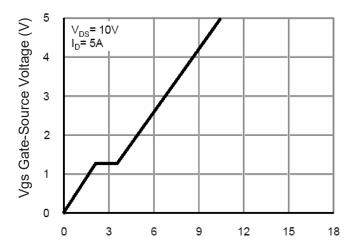
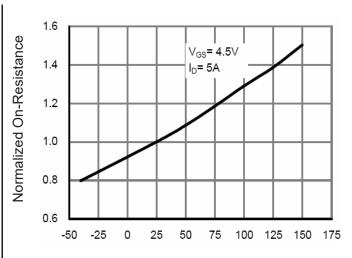


Figure 9 Rdson vs Vgs



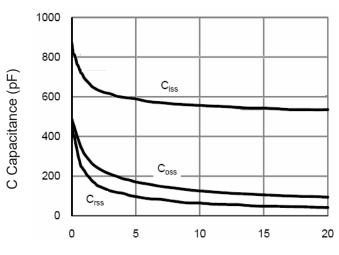
Qg Gate Charge (nC)

Figure 11 Gate Charge



 $T_J$ -Junction Temperature( $^{\circ}$ C)

Figure 8 Drain-Source On-Resistance



Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds

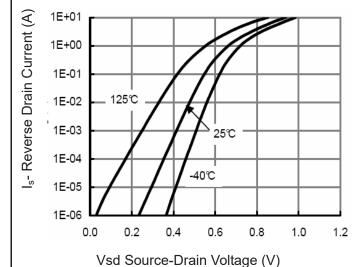
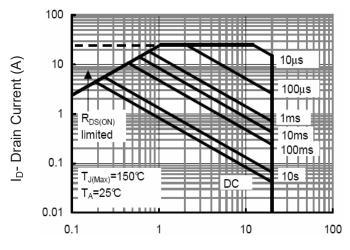


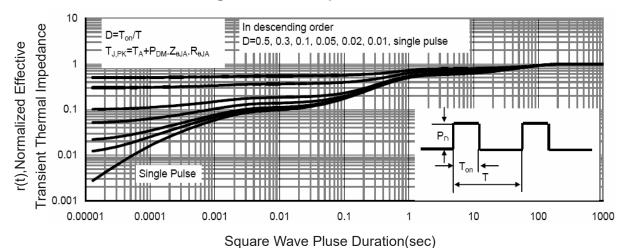
Figure 12 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area



**Figure 14 Normalized Maximum Transient Thermal Impedance**